

Class	Subject
438	690

# U.S. UTILITY Patent Application

SA	O.I.P.E.	PATENT EXAM
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APPLICATION NO. 09/848997	CONT/PRIOR	CLASS 438	SUBCLASS 690	ART UNIT 28/200	EXAMINER <i>Guerrero</i>
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APPLICANTS  
Lup Leong

TITLE  
Thermal mechanical planarization in integrated circuits

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PTO-2040  
12/89

<p>has been claimed.</p> <p>The term of this patent shall</p> <p>and extend forward to expiration date</p>	<p>(Assistant Examiner)</p> <p>(Date)</p>
<p>has been claimed</p> <p>months of</p> <p>this patent have been claimed.</p>	<p>(Primary Examiner)</p> <p>(Date)</p>
	<p>(Legal Examiner)</p> <p>(Date)</p>

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